



28LV64A

64K (8K x 8) Low Voltage CMOS EEPROM

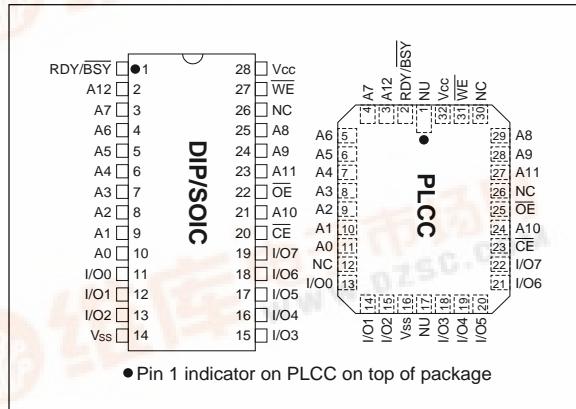
FEATURES

- 2.7V to 3.6V Supply
- Read Access Time—300 ns
- CMOS Technology for Low Power Dissipation
 - 8 mA Active
 - 50 μ A CMOS Standby Current
- Byte Write Time—3 ms
- Data Retention >200 years
- High Endurance - Minimum 100,000 Erase/Write Cycles
- Automatic Write Operation
 - Internal Control Timer
 - Auto-Clear Before Write Operation
 - On-Chip Address and Data Latches
- Data Polling
- Ready/Busy
- Chip Clear Operation
- Enhanced Data Protection
 - Vcc Detector
 - Pulse Filter
 - Write Inhibit
- Electronic Signature for Device Identification
- Organized 8Kx8 JEDEC Standard Pinout
 - 28-pin Dual-In-Line Package
 - 32-pin Chip Carrier (Leadless or Plastic)
- Available for Extended Temperature Ranges:
 - Commercial: 0°C to +70°C
 - Industrial: -40°C to +85°C

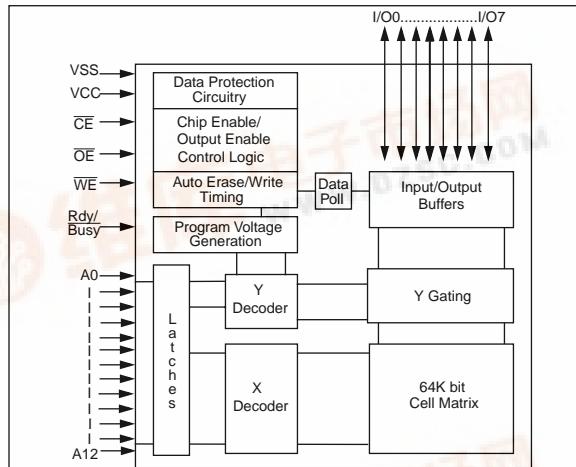
DESCRIPTION

The Microchip Technology Inc. 28LV64A is a CMOS 64K non-volatile electrically Erasable PROM organized as 8K words by 8 bits. The 28LV64A is accessed like a static RAM for the read or write cycles without the need of external components. During a "byte write", the address and data are latched internally, freeing the microprocessor address and data bus for other operations. Following the initiation of write cycle, the device will go to a busy state and automatically clear and write the latched data using an internal control timer. To determine when the write cycle is complete, the user has a choice of monitoring the Ready/Busy output or using Data polling. The Ready/Busy pin is an open drain output, which allows easy configuration in 'wired-or' systems. Alternatively, Data polling allows the user to read the location last written to when the write operation is complete. CMOS design and processing enables this part to be used in systems where reduced power consumption and reliability are required. A complete family of packages is offered to provide the utmost flexibility in applications.

PACKAGE TYPES



BLOCK DIAGRAM



28LV64A

1.0 ELECTRICAL CHARACTERISTICS

MAXIMUM RATINGS*

VCC and input voltages w.r.t. Vss -0.6V to + 6.25V
 Voltage on \overline{OE} w.r.t. Vss -0.6V to +13.5V
 Voltage on A9 w.r.t. Vss -0.6V to +13.5V
 Output Voltage w.r.t. Vss -0.6V to VCC+0.6V
 Storage temperature -65°C to +150°C
 Ambient temp. with power applied -55°C to +125°C

*Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 1-1: PIN FUNCTION TABLE

Name	Function
A0 - A12	Address Inputs
\overline{CE}	Chip Enable
\overline{OE}	Output Enable
\overline{WE}	Write Enable
I/O0 - I/O7	Data Inputs/Outputs
RDY/Busy	Ready/Busy
Vcc	+ Power Supply
Vss	Ground
NC	No Connect; No Internal Connection
NU	Not Used; No External Connection is Allowed

TABLE 1-2: READ/WRITE OPERATION DC CHARACTERISTICS

Vcc = 2.7 to 3.6V Commercial (C): Tamb = 0°C to 70°C Industrial (I): Tamb = -40°C to 85°C						
Parameter	Status	Symbol	Min	Max	Units	Conditions
Input Voltages	Logic "1" Logic "2"	VIH VIL	2.0	0.6	V	
Input Leakage	—	ILI	—	5	µA	VIN = 0V to Vcc+1
Input Capacitance	—	CIN	—	6	pF	Vin = 0V; Tamb = 25°C; f = 1 MHz (Note 1)
Output Voltages	Logic "1" Logic "0"	VOH VOL	2.0	0.3	V	IOH = -100µA IOL = 1.0 mA IOL = 2.0 mA for RDY/Busy
Output Leakage	—	ILO	—	5	µA	VOUT = 0V to Vcc+0.1V
Output Capacitance	—	COUT	—	12	pF	VOUT = 0V; Tamb = 25°C; f = 1 MHz (Note 1)
Power Supply Current, Activity	TTL input	Icc	—	8	mA	f = 5 MHz (Note 2) Io = 0mA Vcc = 3.3 CE = VIL
Power Supply Current, Standby	TTL input TTL input CMOS input	Icc(s)TTL Icc(s)TTL Icc(s)CMOS	—	2 3 100	mA mA µA	$\overline{CE} = VIH$ (0°C to 70°C) $\overline{CE} = VIH$ (-40°C to 85°C) $\overline{CE} = Vcc$ -3.0 to Vcc+1 $\overline{OE} = \overline{WE} = Vcc$ All other inputs equal Vcc or Vss

Note 1: Not 100% tested.
 2: AC power supply current above 5 MHz: 2 mA/Mhz.

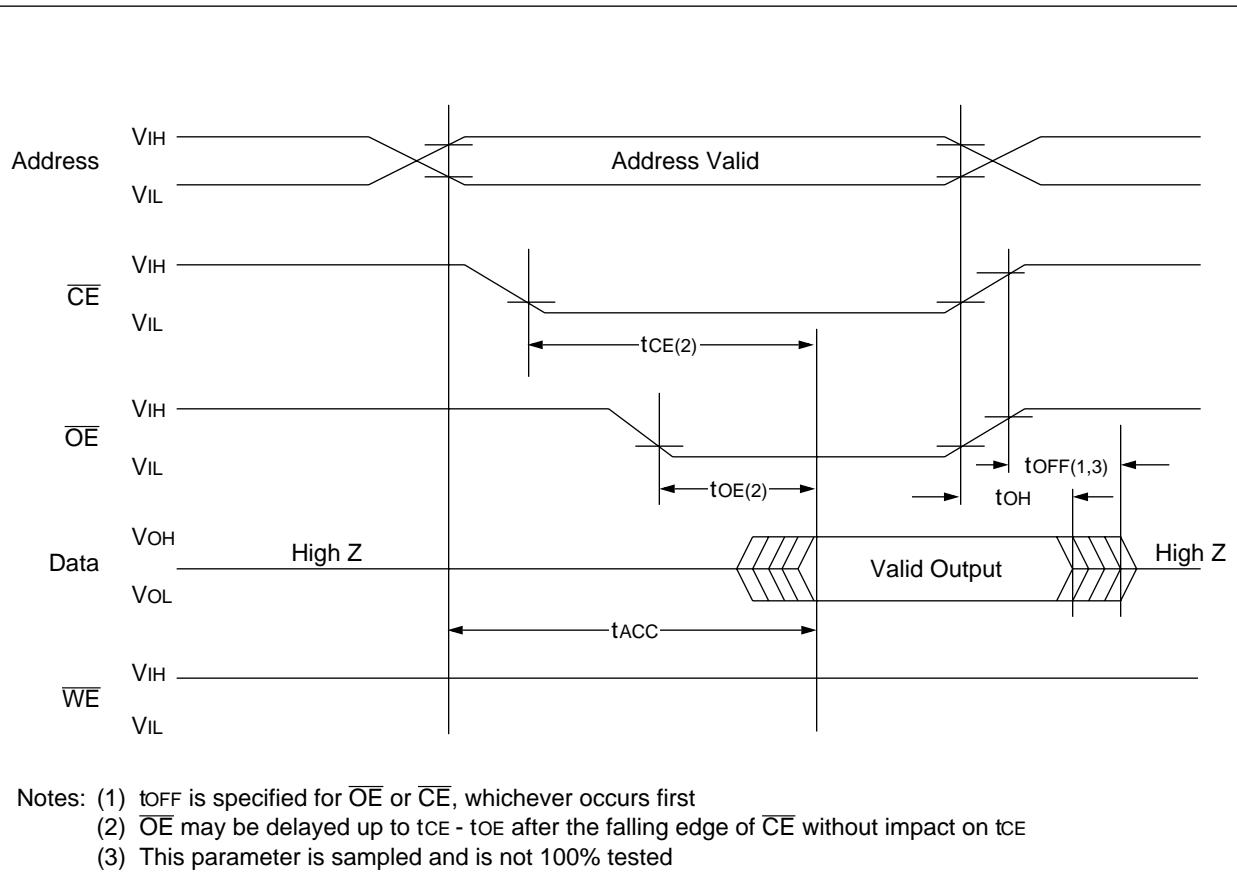
TABLE 1-3: READ OPERATION AC CHARACTERISTICS

		AC Testing Waveform: $V_{IH} = 2.0V$; $V_{IL} = 0.6V$; $V_{OH} = V_{OL} = V_{CC}/2$			
Output Load:		1 TTL Load + 100 pF			
Input Rise and Fall Times:		20 ns			
Ambient Temperature:		Commercial (C): $T_{amb} = 0^{\circ}C$ to $+70^{\circ}C$ Industrial (I) : $T_{amb} = -40^{\circ}C$ to $+85^{\circ}C$			
Parameter	Sym	28LV64-30		Units	Conditions
		Min	Max		
Address to Output Delay	tACC	—	300	ns	$\overline{OE} = \overline{CE} = V_{IL}$
\overline{CE} to Output Delay	tCE	—	300	ns	$\overline{OE} = V_{IL}$
\overline{OE} to Output Delay	toE	—	150	ns	$\overline{CE} = V_{IL}$
\overline{CE} or \overline{OE} High to Output Float	toFF	0	60	ns	(Note 1)
Output Hold from Address, \overline{CE} or \overline{OE} , whichever occurs first.	toH	0	—	ns	(Note 1)
Endurance	—	10M	—	cycles	$25^{\circ}C$, $V_{CC} = 5.0V$, Block Mode (Note 2)

Note 1: Not 100% tested.

2: This parameter is not tested but guaranteed by characterization. For endurance estimates in a specific application, please consult the Total Endurance Model which can be obtained on our BBS or website.

FIGURE 1-1: READ WAVEFORMS



28LV64A

TABLE 1-4: BYTE WRITE AC CHARACTERISTICS

		AC Testing Waveform:	VIH = 2.0V; VIL = 0.6V; VOH = VOL = Vcc/2		
		Output Load:	1 TTL Load + 100 pF		
		Input Rise/Fall Times:	20 ns		
		Ambient Temperature:	Commercial (C): Tamb = 0°C to +70°C Industrial (I) : Tamb = -40°C to +85°C		
Parameter	Sym	Min	Max	Units	Remarks
Address Set-Up Time	tAS	10		ns	
Address Hold Time	tAH	100		ns	
Data Set-Up Time	tDS	120		ns	
Data Hold Time	tDH	10		ns	
Write Pulse Width	twPL	150		ns	(Note 1)
OE Hold Time	toEH	10		ns	
OE Set-Up Time	toES	10		ns	
Data Valid Time	tdV		1000	ns	(Note 2)
Time to Device Busy	tDB		50	ns	
Write Cycle Time (28LV64A)	tWC		3	ms	1.5 ms typical

Note 1: A write cycle can be initiated by \overline{CE} or \overline{WE} going low, whichever occurs last. The data is latched on the positive edge of \overline{CE} or \overline{WE} , whichever occurs first.

2: Data must be valid within 1000ns max. after a write cycle is initiated and must be stable at least until tDH after the positive edge of \overline{WE} or \overline{CE} , whichever occurs first.

FIGURE 1-2: PROGRAMMING WAVEFORMS

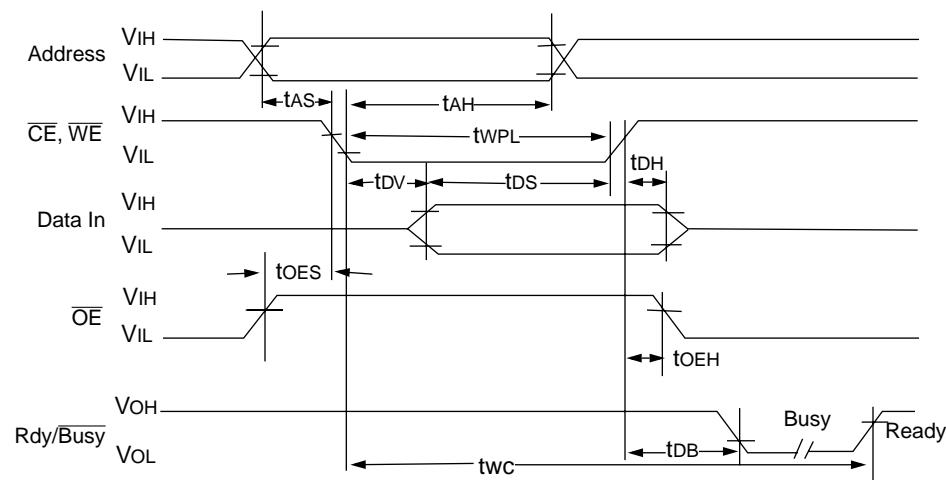


FIGURE 1-3: DATA POLLING WAVEFORMS

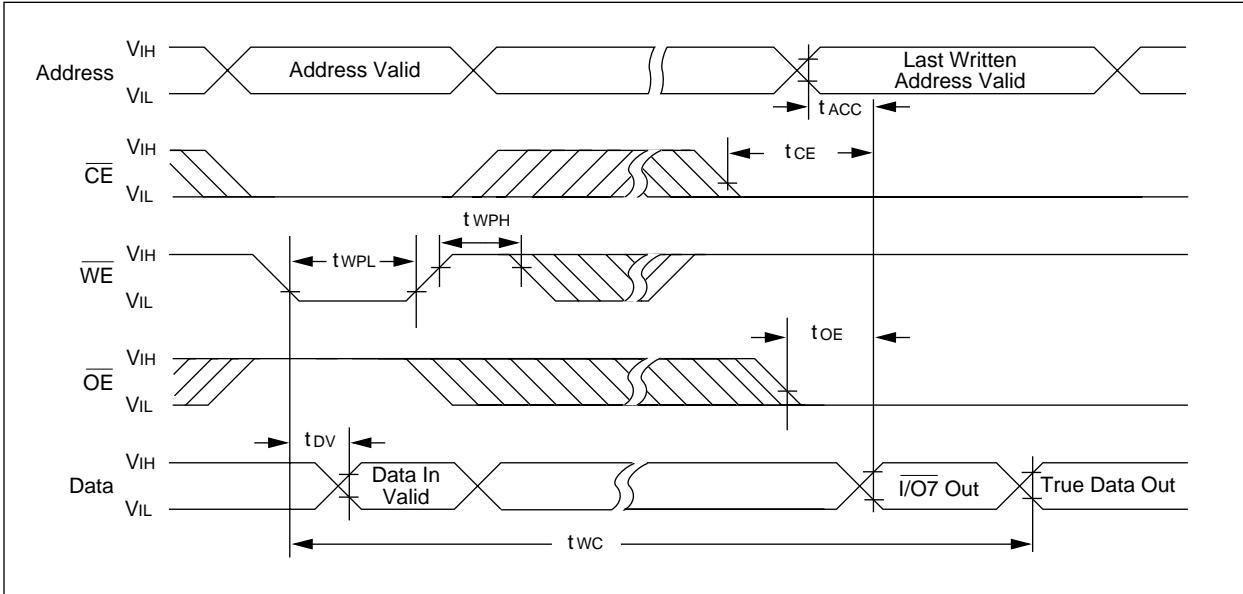


FIGURE 1-4: CHIP CLEAR WAVEFORMS

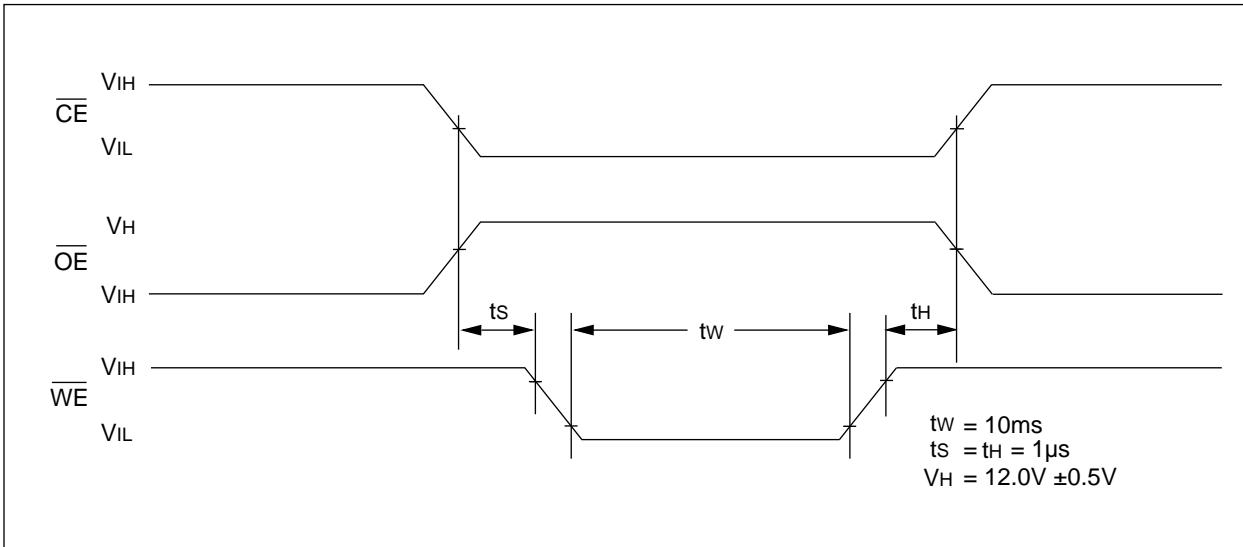


TABLE 1-5: SUPPLEMENTARY CONTROL

Mode	CE	OE	WE	A ₁	V _{cc}	I/O ₁
Chip Clear	V _{IL}	V _H		X	V _{cc}	
Extra Row Read	V _{IL}	V _{IL}	V _{ih}	A ₉ = V _H	V _{cc}	Data Out
Extra Row Write		V _{ih}		A ₉ = V _H	V _{cc}	Data In

Note: $V_H = 12.0\text{V} \pm 0.5\text{V}$

28LV64A

2.0 DEVICE OPERATION

The Microchip Technology Inc. 28LV64A has four basic modes of operation—read, standby, write inhibit, and byte write—as outlined in the following table.

Operation Mode	\overline{CE}	\overline{OE}	\overline{WE}	I/O	Rdy/ \overline{Busy} (1)
Read	L	L	H	Dout	H
Standby	H	X	X	High Z	H
Write Inhibit	H	X	X	High Z	H
Write Inhibit	X	L	X	High Z	H
Write Inhibit	X	X	H	High Z	H
Byte Write	L	H	L	DIN	L
Byte Clear				Automatic Before Each "Write"	

Note: (1) Open drain output.

2.1 Read Mode

The 28LV64A has two control functions, both of which must be logically satisfied in order to obtain data at the outputs. Chip enable (\overline{CE}) is the power control and should be used for device selection. Output Enable (\overline{OE}) is the output control and is used to gate data to the output pins independent of device selection. Assuming that addresses are stable, address access time (t_{ACC}) is equal to the delay from \overline{CE} to output (t_{OE}). Data is available at the output t_{OE} after the falling edge of \overline{OE} , assuming that \overline{CE} has been low and addresses have been stable for at least t_{ACC}-t_{OE}.

2.2 Standby Mode

The 28LV64A is placed in the standby mode by applying a high signal to the \overline{CE} input. When in the standby mode, the outputs are in a high impedance state, independent of the \overline{OE} input.

2.3 Data Protection

In order to ensure data integrity, especially during critical power-up and power-down transitions, the following enhanced data protection circuits are incorporated:

First, an internal V_{CC} detect (2.0 volts typical) will inhibit the initiation of non-volatile programming operation when V_{CC} is less than the V_{CC} detect circuit trip.

Second, holding \overline{WE} or \overline{CE} high or \overline{OE} low, inhibits a write cycle during power-on and power-off (V_{CC}).

2.4 Write Mode

The 28LV64A has a write cycle similar to that of a static RAM. The write cycle is completely self-timed and initiated by a low going pulse on the \overline{WE} pin. On the falling edge of \overline{WE} , the address information is latched. On rising edge, the data and the control pins (\overline{CE} and \overline{OE}) are latched. The Ready/Busy pin goes to a logic low level indicating that the 28LV64A is in a write cycle which signals the microprocessor host that the system bus is free for other activity. When Ready/Busy goes back to a high, the 28LV64A has completed writing and is ready to accept another cycle.

2.5 Data Polling

The 28LV64A features Data polling to signal the completion of a byte write cycle. During a write cycle, an attempted read of the last byte written results in the data complement of I/O7 (I/O0 to I/O6 can not be determined). After completion of the write cycle, true data is available. Data polling allows a simple read/compare operation to determine the status of the chip eliminating the need for external hardware.

2.6 Electronic Signature for Device Identification

An extra row of 32 bytes of EEPROM memory is available to the user for device identification. By raising A9 to 12V ± 0.5 V and using address locations 1FF0 to 1FFF, the additional bytes can be written to or read from in the same manner as the regular memory array.

2.7 Chip Clear

All data may be cleared to 1's in a chip clear cycle by raising \overline{OE} to 12 volts and bringing the \overline{WE} and CE low. This procedure clears all data, except for the extra row.

28LV64A

28LV64A Product Identification System

To order or to obtain information (e.g., on pricing or delivery), please use the listed part numbers, and refer to the factory or the listed sales offices.

28LV64A	-	F	T	-	20	I	/P	
								Package:
								L = Plastic Leaded Chip Carrier (PLCC)
								P = Plastic DIP
								SO = Plastic Small Outline IC
						Temperature Range:		Blank = 0°C to +70°C
								I = -40°C to +85°C
						Access Time:		20 = 200 ns
								30 - 300 ns
						Shipping:		Blank = Tube
								T = Tape and Reel "L" and "SO"
						Option:		Blank = twc = 1ms
								F = twc = 200μs
						Device:		24LV64A 8K x 8 CMOS EEPROM

**MICROCHIP****WORLDWIDE SALES AND SERVICE****AMERICAS****Corporate Office**

Microchip Technology Inc.
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 602-786-7200 Fax: 602-786-7277
Technical Support: 602 786-7627
Web: <http://www.microchip.com>

Atlanta

Microchip Technology Inc.
500 Sugar Mill Road, Suite 200B
Atlanta, GA 30350
Tel: 770-640-0034 Fax: 770-640-0307

Boston

Microchip Technology Inc.
5 Mount Royal Avenue
Marlborough, MA 01752
Tel: 508-480-9990 Fax: 508-480-8575

Chicago

Microchip Technology Inc.
333 Pierce Road, Suite 180
Itasca, IL 60143
Tel: 630-285-0071 Fax: 630-285-0075

Dallas

Microchip Technology Inc.
14651 Dallas Parkway, Suite 816
Dallas, TX 75240-8809
Tel: 972-991-7177 Fax: 972-991-8588

Dayton

Microchip Technology Inc.
Two Prestige Place, Suite 150
Miamisburg, OH 45342
Tel: 937-291-1654 Fax: 937-291-9175

Detroit

Microchip Technology Inc.
42705 Grand River, Suite 201
Novi, MI 48375-1727
Tel: 248-374-1888 Fax: 248-374-2874

Los Angeles

Microchip Technology Inc.
18201 Von Karman, Suite 1090
Irvine, CA 92612
Tel: 714-263-1888 Fax: 714-263-1338

New York

Microchip Technology Inc.
150 Motor Parkway, Suite 202
Hauppauge, NY 11788
Tel: 516-273-5305 Fax: 516-273-5335

San Jose

Microchip Technology Inc.
2107 North First Street, Suite 590
San Jose, CA 95131
Tel: 408-436-7950 Fax: 408-436-7955

AMERICAS (continued)**Toronto**

Microchip Technology Inc.
5925 Airport Road, Suite 200
Mississauga, Ontario L4V 1W1, Canada
Tel: 905-405-6279 Fax: 905-405-6253

ASIA/PACIFIC**Hong Kong**

Microchip Asia Pacific
RM 3801B, Tower Two
Metroplaza
223 Hing Fong Road
Kwai Fong, N.T., Hong Kong
Tel: 852-2-401-1200 Fax: 852-2-401-3431

India

Microchip Technology Inc.
India Liaison Office
No. 6, Legacy, Convent Road
Bangalore 560 025, India
Tel: 91-80-229-0061 Fax: 91-80-229-0062

Japan

Microchip Technology Intl. Inc.
Benex S-1 6F
3-18-20, Shinyokohama
Kohoku-Ku, Yokohama-shi
Kanagawa 222-0033 Japan
Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea

Microchip Technology Korea
168-1, Youngbo Bldg. 3 Floor
Samsung-Dong, Kangnam-Ku
Seoul, Korea
Tel: 82-2-554-7200 Fax: 82-2-558-5934

Shanghai

Microchip Technology
RM 406 Shanghai Golden Bridge Bldg.
2077 Yan'an Road West, Hong Qiao District
Shanghai, PRC 200335
Tel: 86-21-6275-5700 Fax: 86 21-6275-5060

ASIA/PACIFIC (continued)**Singapore**

Microchip Technology Singapore Pte Ltd.
200 Middle Road
#07-02 Prime Centre
Singapore 188980
Tel: 65-334-8870 Fax: 65-334-8850

Taiwan, R.O.C

Microchip Technology Taiwan
10F-1C 207
Tung Hua North Road
Taipei, Taiwan, ROC
Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE**United Kingdom**

Arizona Microchip Technology Ltd.
505 Eskdale Road
Winnersh Triangle
Wokingham
Berkshire, England RG41 5TU
Tel: 44-1189-21-5858 Fax: 44-1189-21-5835

France

Arizona Microchip Technology SARL
Zone Industrielle de la Bonde
2 Rue du Buisson aux Fraises
91300 Massy, France
Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany

Arizona Microchip Technology GmbH
Gustav-Heinemann-Ring 125
D-81739 München, Germany
Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

Italy

Arizona Microchip Technology SRL
Centro Direzionale Colleoni
Palazzo Taurus 1 V. Le Colleoni 1
20041 Agrate Brianza
Milan, Italy
Tel: 39-39-6899939 Fax: 39-39-6899883

9/8/98



Microchip received ISO 9001 Quality System certification for its worldwide headquarters, design, and wafer fabrication facilities in January, 1997. Our field-programmable PICmicro™ 8-bit MCUs, Serial EEPROMs, related specialty memory products and development systems conform to the stringent quality standards of the International Standard Organization (ISO).